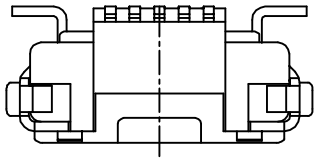
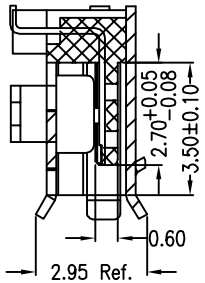
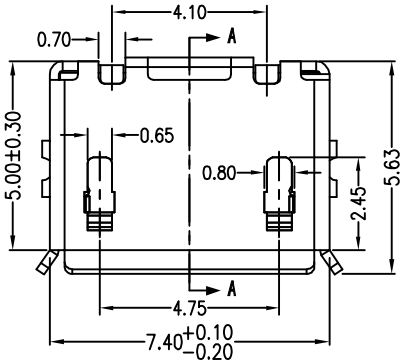
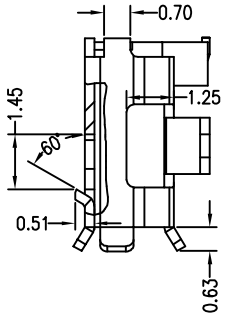
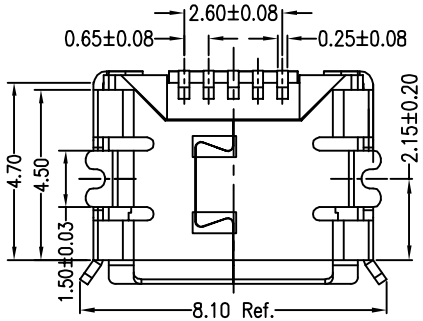
REV.	ECN NO	LOCATIONS	DESCRIPTION	DATE

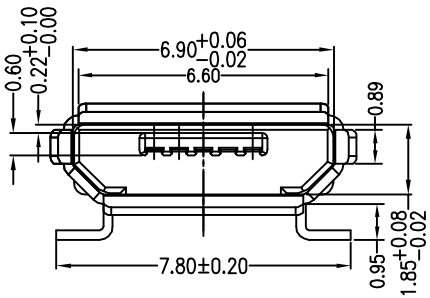


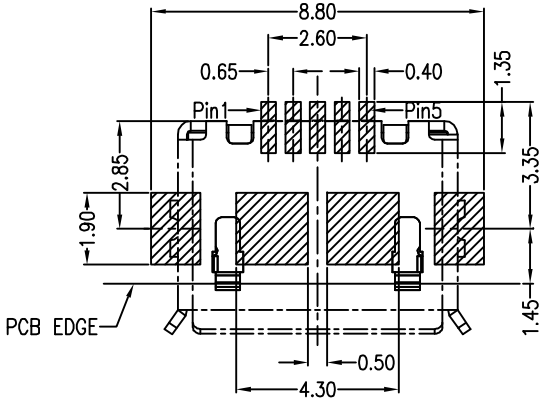












RECOMMANDED PCB LAYOUT

Note:
1.Material:
- 1.1 Housing: High temperature thermoplastic with g.f,UL94v-0
- 1.2 Contact: copper alloy,t=0.20mm
- 1.3 Shell: copper alloy,t=0.25mm

2.Specification:
- 2.1 Current rating: 1 A Max.
- 2.2 Dielectric withstanding voltage: 100 V(ac) for 1 min.
- 2.3 Contact resistance: 50 mW Max.
- 2.4 Insulation resistance: 100 MW Min.
- 2.5 Total mating force: 3.57 Kgf Max.
- 2.6 Total unmating force: 1.0 Kgf Min.0.81~2.05 Kgf Min.after 10000 insertion/extration cycles
- 2.7 Temperature range: -30°C~80°C

A 01 S B X X X X X X X 2-061
① ② ③ ④ ⑤ ⑥ ⑦ ⑧ ⑨ ⑩ ⑪ ⑫ ⑬

① 产品代号	A:成品	⑥ 外壳电镀	0:素材;1:Ni100u'';2:雾Sn100u'';3:Ni+Au1u''(脚);4:全Au1u''
② 产品系列	01:micro usb 5pin	⑦ 端子材质	4:C5191R-EH 2:C2680R-EH
③ 产品类别	S:母座	⑧ 端子电镀	0:素材;1:全Au1u'';2:全Au1.5u'';3:全Au3u'';4:全Au10u'';6:全Au15u'';8:全Au30u'';7:亮Sn+Au1u'';8:亮Sn+Au3u'' A:雾镍+Au1u'';B:雾镍Au1.5u'';C:雾镍Au3u'';D:雾镍Au5u''
④ 产品类型	B:B TYPE	⑨ 主体材质	1:LCP
⑤ 外壳材质	1:C2680R-H	⑩ 主体颜色	B:黑色 W:白色
⑪ 包装方式	1:吸塑管;2:卷带;4:pe袋	⑫ 下板类型	2:SMT
⑬ 细节流水	061:Micro USB 5S B Type-垫高0.9外壳SMT		

PART NO: A01SBXXXXXXX2-061		MATERAL: SEE NOTE	深圳市顺宏康科技有限公司
MODEL NO: XX		FINSH: SEE NOTE	
UNIT: MM	SIZE: A4	COLOR: SEE NOTE	TITLE: Micro USB 5S B Type-垫高0.9外壳SMT
TOLERANCE UNSPECIFIED .x 0.25 .xx 0.15 .xxx 0.10 Ang. 2°		DR: 夏友红	DWG NO: SHK-20048 REV: A
		CHK:	SCALE: 5:1 DATE: 2012.05.22
		APP:	